

Senior Layout and Physical Design Engineer (f/m/d)

ChipGlobe is focusing on Design– and Verification Consulting with both Insourcing (at Customer premises) and Outsourcing (ChipGlobe Design Center) working models. Our teams work in a global setup with ASIC design, verification and software teams in major semiconductor companies, focusing on markets in automotive, telecommunications, security and networking. ChipGlobe headquarters is located in Munich, Germany with a ChipGlobe Entity in Singapore, a ChipGlobe Design Center in Belgrade, Serbia and Ho Chi Minh City, Vietnam. We are more than 70 experts with an experienced management team. Based on the strong experience of our staff we manage and execute projects in a well-communicated, success-proven and sustainable way. We love what we do and we do what we love.

ChipGlobe Offering:

- ✓ Opportunity to work for stable, expanding German company with mature management, that is technically involved
- Excellent working environment, encouraging both technical and personal involvement
- ✓ Work together with a team of 70+ senior experts across multiple expertise domains in a global team setup
- ✓ Strategic partnerships with leading semiconductor companies. Transparent ChipGlobe yearly bonus system

Job requirements – Technical Skills

- Include all aspects of physical design including synthesis, floor planning, place and route, Clock Tree Synthesis, Clock Distribution, extraction, Timing closure, Power and Signal Integrity Analysis, Physical Verification, DFM and Tape Out.
- ✓ Education: B.Tech/BE/ME/M.Tech
- ✓ Efficient communication skills to interface with Front End Design team to resolve Design Issues
- ✓ 3-7 years of hands on experience, P&R from RTL to GDS including timing closure and Physical verification.
- ✓ Design experience in all aspects of physical design.
- ✓ Expert knowledge of Synopsys IC-Compiler and proficient and powerful user of Synopsys Tool Suite (DC/ICC/Star/PT).
- ✓ Technologies: 28nm and below.
- ✓ Experience in Mentor Calibre tools to run Physical verification and/or in ANSYS Redhawk to run IR-analysis is a Plus.
- ✓ Experience in Tcl/Tk, PERL, Makefile is a Plus

Job requirements – Soft Skills

- Communication
 - Able to abstract technical details. Open to communicate with people on and off site. Open-minded.
 - Excellent communication skills, enjoys working in an international team across locations
 - Very good level of spoken and written English (at least B2 level).
 - Strong presentation and listening skills are required
- ✓ Team player
 - Committed to the team and task
 - Helping team members, sharing knowledge
- Self-driven and highly motivated
 - Self-motivated and self-dependent worker. Embracing the task. Highlight potential issues
- Regular reporting. Clean and organized working style. Able to go the extra mile
- Solution oriented attitude, pragmatic. Good problem solving skills
 - Following and improving processes
 - Able to follow corporate reporting standards
 - Organized, trusted, committed to a long term employment at Chipglobe
 - Quality awareness

If you are interested in this position, please send your CV and the reason why you would like to join ChipGlobe to:

employment@chipglobe.com

Chipglobe GmbH, Cincinnatistr. 60, 81549 München. Gerichtsstand München, HRB 209 414, Geschäftsführung Volker Frisch Umsatzsteuer-Identifikationsnummer gemäß §27 a Umsatzsteuergesetz: DE293062415 - 2.4.2019-DR